

## Contents

<b>Pin Configurations</b> .....	<b>3</b>	<b>Ordering Information</b> .....	<b>15</b>
<b>Pin Definitions</b> .....	<b>3</b>	Ordering Code Definitions .....	15
<b>Selection Guide</b> .....	<b>3</b>	<b>Package Diagrams</b> .....	<b>16</b>
<b>Maximum Ratings</b> .....	<b>4</b>	<b>Acronyms</b> .....	<b>17</b>
<b>Operating Range</b> .....	<b>4</b>	<b>Document Conventions</b> .....	<b>17</b>
<b>Electrical Characteristics</b> .....	<b>4</b>	Units of Measure .....	17
<b>Capacitance</b> .....	<b>5</b>	<b>Document History Page</b> .....	<b>18</b>
<b>AC Test Loads and Waveforms</b> .....	<b>5</b>	<b>Sales, Solutions, and Legal Information</b> .....	<b>19</b>
<b>Switching Characteristics</b> .....	<b>6</b>	Worldwide Sales and Design Support .....	19
<b>Switching Characteristics</b> .....	<b>8</b>	Products .....	19
<b>Switching Waveforms</b> .....	<b>10</b>	PSoC Solutions .....	19

## Pin Configurations

Figure 1. Pin Diagram - 52-pin PLCC (Top View)

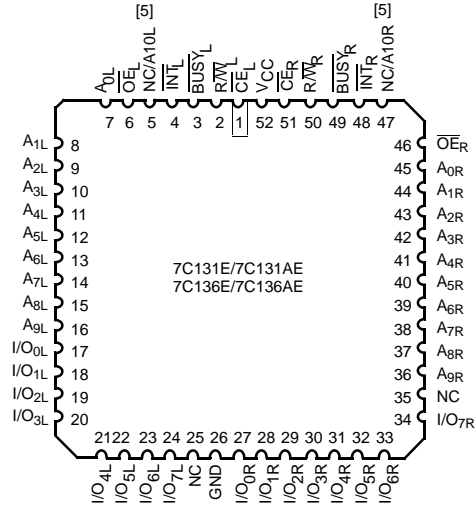
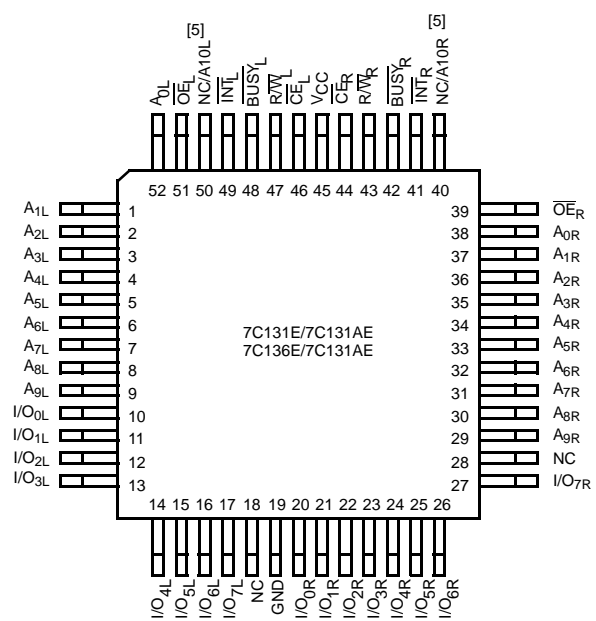


Figure 2. Pin Diagram - 52-pin PQFP (Top View)



## Pin Definitions

Left Port	Right Port	Description
$\overline{CE}_L$	$\overline{CE}_R$	Chip Enable
$\overline{R/W}_L$	$\overline{R/W}_R$	Read/Write Enable
$\overline{OE}_L$	$\overline{OE}_R$	Output Enable
$A_{0L}-A_{9/10L}$ [5]	$A_{0R}-A_{9/10R}$ [5]	Address
$I/O_{0L}-I/O_{7L}$	$I/O_{0R}-I/O_{7R}$	Data Bus Input/Output
$\overline{INT}_L$	$\overline{INT}_R$	Interrupt Flag
$\overline{BUSY}_L$	$\overline{BUSY}_R$	Busy Flag
$V_{CC}$		Power
$GND$		Ground

## Selection Guide

Parameter	7C131E-15 7C131AE-15	7C131E-25 7C136E-25	7C131E-55 7C136E-55 7C136AE-55	Unit
Maximum Access Time	15	25	55	ns
Typical Operating Current	110	100	95	mA
Typical Standby Current for $I_{SB1}$ (both ports TTL level)	50	45	45	mA
Typical Standby Current for $I_{SB3}$ (Both ports CMOS level)	0.05	0.05	0.05	mA

**Note**

5. 1 K x 8: A0-A9, 2 K x 8: A0-A10, address lines are for both left and right ports.

## Maximum Ratings

Exceeding maximum ratings <sup>[6]</sup> may shorten the useful life of the device. User guidelines are not tested.

Storage temperature ..... -65 °C to +150 °C  
 Ambient temperature with power applied ..... -55 °C to +125 °C  
 Supply voltage to ground potential ..... -0.3 V to +7.0 V  
 DC voltage applied to outputs in High Z State ..... -0.5 V to +7.0 V

DC input voltage<sup>[8]</sup> ..... -0.5 V to +7.0 V  
 Output current into outputs (LOW) ..... 20 mA  
 Static discharge voltage ..... >1100 V  
 Latch up current ..... >200 mA

## Operating Range

Range	Ambient Temperature	V <sub>CC</sub>
Commercial	0 °C to +70 °C	5 V ± 10%
Industrial	-40 °C to +85 °C	5 V ± 10%

## Electrical Characteristics

Over the Operating Range

Parameter	Description	Test Conditions	7C131E-15 7C131AE-15			7C131E-25 7C136E-25			7C131E-55 7C136E-55 7C136AE-55			Unit
			Min	Typ <sup>[9]</sup>	Max	Min	Typ <sup>[9]</sup>	Max	Min	Typ <sup>[9]</sup>	Max	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min, I <sub>OH</sub> = -4.0 mA	2.4	-	-	2.4	-	-	2.4	-	-	V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min, I <sub>OL</sub> = 4.0 mA	-	-	0.4	-	-	0.4	-	-	0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	-	-	2.2	-	-	2.2	-	-	V
V <sub>IL</sub>	Input LOW Voltage		-	-	0.8	-	-	0.8	-	-	0.8	V
I <sub>OZ</sub>	Output Leakage Current	GND ≤ V <sub>O</sub> ≤ V <sub>CC</sub> , Output disabled	-20	-	+20	-20	-	+20	-20	-	+20	µA
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	V <sub>CC</sub> = Max, I <sub>OUT</sub> = 0 mA Outputs disabled	-	110 115	190 200	-	100 110	170 180	-	95 105	160 170	mA
I <sub>SB1</sub>	Standby Current, Both Ports, TTL Inputs	CE <sub>L</sub> and CE <sub>R</sub> ≥ V <sub>IH</sub> , f = f <sub>MAX</sub> <sup>[7]</sup>	-	50 65	70 95	-	45 65	65 95	-	45 65	65 95	mA
I <sub>SB2</sub>	Standby Current, One Port, TTL Inputs	CE <sub>L</sub> or CE <sub>R</sub> ≥ V <sub>IH</sub> , Active Port Outputs Open, f = f <sub>MAX</sub> <sup>[7]</sup>	-	120 135	180 205	-	110 135	160 205	-	110 135	160 205	mA
I <sub>SB3</sub>	Standby Current, Both Ports, CMOS Inputs	<u>Both Ports</u> CE <sub>L</sub> and CE <sub>R</sub> ≥ V <sub>CC</sub> - 0.2 V, V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V or V <sub>IN</sub> ≤ 0.2 V, f = 0	-	0.05 0.05	0.5 0.5	-	0.05 0.05	0.5 0.5	-	0.05 0.05	0.5 0.5	mA
I <sub>SB4</sub>	Standby Current, One Port, CMOS Inputs	<u>One Port</u> CE <sub>L</sub> or CE <sub>R</sub> ≥ V <sub>CC</sub> - 0.2 V, V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2 V or V <sub>IN</sub> ≤ 0.2 V, Active Port Outputs Open, f = f <sub>MAX</sub> <sup>[7]</sup>	-	110 125	160 175	-	100 125	140 175	-	100 125	140 175	mA

### Notes

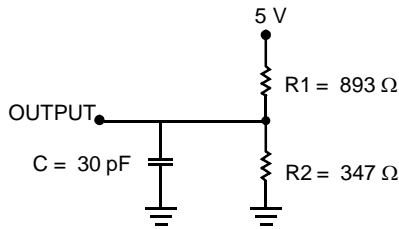
- The voltage on any I/O pin cannot exceed the power pin during power-up.
- At f = f<sub>MAX</sub>, address and data inputs are cycling at the maximum frequency of read cycle of 1/t<sub>RC</sub> and using AC Test Waveforms input levels of GND to 3 V.
- Pulse width < 20 ns.
- Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at V<sub>CC</sub> = V<sub>CC</sub>(typ.), T<sub>A</sub> = 25 °C.

### Capacitance<sup>[10]</sup>

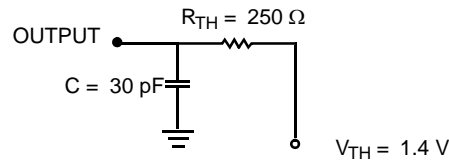
Parameter	Description	Test Conditions	Max	Unit
C <sub>IN</sub>	Input capacitance	T <sub>A</sub> = 25 °C, f = 1 MHz, V <sub>CC</sub> = 5.0 V	15	pF
C <sub>OUT</sub>	Output capacitance		10	pF

### AC Test Loads and Waveforms

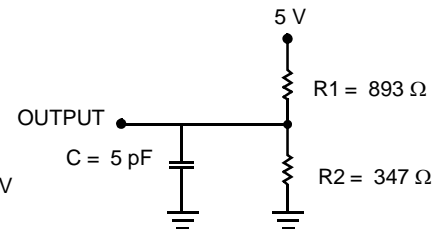
Figure 3. AC Test Loads and Waveforms



(a) Normal Load (Load 1)

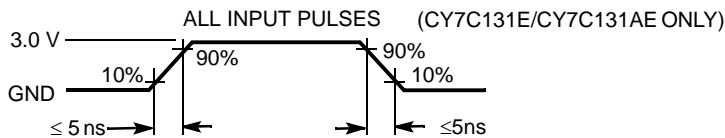


(b) Thévenin Equivalent (Load 1)



(c) Three-State Delay (Load 2)

(Used for t<sub>LZ</sub>, t<sub>HZ</sub>, t<sub>HZWE</sub>, and t<sub>LZWE</sub> including scope and jig)



**Note**

10. Tested initially and after any design or process changes that may affect these parameters.

## Switching Characteristics

Over the Operating Range

Parameter <sup>[11]</sup>	Description	7C131E-15/7C131AE-15		7C131E-25/7C136E-25		Unit
		Min	Max	Min	Max	
<b>Read Cycle</b>						
$t_{RC}$	Read cycle time	15	–	25	–	ns
$t_{AA}$	Address to data valid <sup>[12]</sup>	–	15	–	25	ns
$t_{OHA}$	Data hold from Address change	3	–	3	–	ns
$t_{ACE}$	$\overline{CE}$ LOW to data valid <sup>[12]</sup>	–	15	–	25	ns
$t_{DOE}$	$\overline{OE}$ LOW to data valid <sup>[12]</sup>	–	10	–	15	ns
$t_{LZOE}$	$\overline{OE}$ LOW to Low Z <sup>[13, 14, 15]</sup>	3	–	3	–	ns
$t_{HZOE}$	$\overline{OE}$ HIGH to High Z <sup>[13, 14, 15]</sup>	–	10	–	15	ns
$t_{LZCE}$	$\overline{CE}$ LOW to Low Z <sup>[13, 14, 15]</sup>	3	–	5	–	ns
$t_{HZCE}$	$\overline{CE}$ HIGH to High Z <sup>[13, 14, 15]</sup>	–	10	–	15	ns
$t_{PU}$	$\overline{CE}$ LOW to power-up <sup>[13]</sup>	0	–	0	–	ns
$t_{PD}$	$\overline{CE}$ HIGH to power-down <sup>[13]</sup>	–	15	–	25	ns
<b>Write Cycle <sup>[16]</sup></b>						
$t_{WC}$	Write cycle time	15	–	25	–	ns
$t_{SCE}$	$\overline{CE}$ LOW to write end	12	–	20	–	ns
$t_{AW}$	Address setup to write end	12	–	20	–	ns
$t_{HA}$	Address hold from write end	0	–	0	–	ns
$t_{SA}$	Address setup to write start	0	–	0	–	ns
$t_{PWE}$	R/ $\overline{W}$ pulse width	10	–	12	–	ns
$t_{SD}$	Data setup to write end	10	–	15	–	ns
$t_{HD}$	Data hold from write end	0	–	0	–	ns
$t_{HZWE}^{[13]}$	R/ $\overline{W}$ LOW to High Z <sup>[15]</sup>	–	10	–	15	ns
$t_{LZWE}^{[13]}$	R/ $\overline{W}$ HIGH to Low Z <sup>[15]</sup>	3	–	3	–	ns

### Notes

11. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V and output loading of the specified  $I_{OL}/I_{OH}$  and 30 pF load capacitance.
12. AC Test Conditions use  $V_{OH} = 1.6$  V and  $V_{OL} = 1.4$  V.
13. This parameter is guaranteed but not tested.
14. At any given temperature and voltage condition for any given device,  $t_{HZCE}$  is less than  $t_{LZCE}$  and  $t_{HZOE}$  is less than  $t_{LZOE}$ .
15. Parameters  $t_{LZCE}$ ,  $t_{LZWE}$ ,  $t_{HZOE}$ ,  $t_{LZOE}$ ,  $t_{HZCE}$  and  $t_{HZWE}$  are tested with  $C_L = 5$  pF as in part (c) of [Figure 3 on page 5](#). Transition is measured  $\pm 500$  mV from steady state voltage.
16. The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW and R/ $\overline{W}$  LOW. Both signals must be low to initiate a write and either signal can terminate

## Switching Characteristics (continued)

Over the Operating Range

Parameter <sup>[11]</sup>	Description	7C131E-15/7C131AE-15		7C131E-25/7C136E-25		Unit
		Min	Max	Min	Max	
<b>Busy/Interrupt Timing<sup>[17]</sup></b>						
t <sub>BLA</sub>	BUSY LOW from Address match	–	15	–	20	ns
t <sub>BHA</sub>	BUSY HIGH from Address mismatch <sup>[18]</sup>	–	15	–	20	ns
t <sub>BLC</sub>	BUSY LOW from CE LOW	–	15	–	20	ns
t <sub>BHC</sub>	BUSY HIGH from CE HIGH <sup>[18]</sup>	–	15	–	20	ns
t <sub>PS</sub>	Port setup for priority	5	–	5	–	ns
t <sub>BDD</sub>	BUSY HIGH to valid data	–	15	–	25	ns
t <sub>DDD</sub>	Write data valid to read data valid <sup>[19]</sup>	–	25	–	30	ns
t <sub>WDD</sub>	Write pulse to data delay <sup>[19]</sup>	–	30	–	45	ns
<b>Interrupt Timing</b>						
t <sub>WINS</sub>	R/W to INTERRUPT set time	–	15	–	25	ns
t <sub>EINS</sub>	CE to INTERRUPT set time	–	15	–	25	ns
t <sub>INS</sub>	Address to INTERRUPT set time	–	15	–	25	ns
t <sub>OINR</sub>	OE to INTERRUPT reset time <sup>[18]</sup>	–	15	–	25	ns
t <sub>EINR</sub>	CE to INTERRUPT reset time <sup>[18]</sup>	–	15	–	25	ns
t <sub>INR</sub>	Address to INTERRUPT reset time <sup>[18]</sup>	–	15	–	25	ns

### Notes

17. Test conditions used are Load 2.

18. These parameters are measured from the input signal changing, until the output pin goes to a high impedance state.

19. A write operation on Port A, where Port A has priority, leaves the data on Port B's outputs undisturbed until one access time after one of the following:  
 BUSY on Port B goes HIGH.  
 Port B's address toggled.  
 CE for Port B is toggled.

## Switching Characteristics

Over the Operating Range

Parameter	Description	7C131E-55 7C136E-55 7C136AE-55		Unit
		Min	Max	
<b>Read Cycle</b>				
$t_{RC}$	Read cycle time	55	–	ns
$t_{AA}$	Address to data valid <sup>[21]</sup>	–	55	ns
$t_{OHA}$	Data hold from Address change	3	–	ns
$t_{ACE}$	CE LOW to data valid <sup>[21]</sup>	–	55	ns
$t_{DOE}$	OE LOW to data valid <sup>[21]</sup>	–	25	ns
$t_{LZOE}$	OE LOW to Low Z <sup>[21, 22, 23]</sup>	3	–	ns
$t_{HZOE}$	OE HIGH to High Z <sup>[21, 22, 23]</sup>	–	25	ns
$t_{LZCE}$	CE LOW to Low Z <sup>[21, 22, 23]</sup>	5	–	ns
$t_{HZCE}$	CE HIGH to High Z <sup>[21, 22, 23]</sup>	–	25	ns
$t_{PU}$	CE LOW to power-up <sup>[22]</sup>	0	–	ns
$t_{PD}$	CE HIGH to power-down <sup>[22]</sup>	–	35	ns
<b>Write Cycle</b>				
$t_{WC}$	Write cycle time	55	–	ns
$t_{SCE}$	CE LOW to write end	40	–	ns
$t_{AW}$	Address setup to write end	40	–	ns
$t_{HA}$	Address hold from write end	2	–	ns
$t_{SA}$	Address setup to write start	0	–	ns
$t_{PWE}$	R/W pulse width	30	–	ns
$t_{SD}$	Data setup to write end	20	–	ns
$t_{HD}$	Data hold from write end	0	–	ns
$t_{HZWE}$	R/W LOW to High Z <sup>[24]</sup>	–	25	ns
$t_{LZWE}$	R/W HIGH to Low Z <sup>[24]</sup>	3	–	ns
<b>Busy/Interrupt Timing</b> <sup>[20]</sup>				
$t_{BLA}$	BUSY LOW from Address match	–	30	ns
$t_{BHA}$	BUSY HIGH from Address mismatch <sup>[25]</sup>	–	30	ns
$t_{BLC}$	BUSY LOW from CE LOW	–	30	ns
$t_{BHC}$	BUSY HIGH from CE HIGH <sup>[25]</sup>	–	30	ns
$t_{PS}$	Port setup for priority	5	–	ns
$t_{BDD}$	BUSY HIGH to valid data	–	45	ns

### Notes

20. Test conditions used are Load 2.

21. The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW and  $\overline{R/W}$  LOW. Both signals must be low to initiate a write and either signal can terminate a write by going high. The data input setup and hold timing should be referenced to the rising edge of the signal that terminates the write.

22. AC Test Conditions use  $V_{OH} = 1.6$  V and  $V_{OL} = 1.4$  V.

23. These parameters are measured from the input signal changing, until the output pin goes to a high impedance state.

24. Parameters  $t_{LZCE}$ ,  $t_{LZWE}$ ,  $t_{HZOE}$ ,  $t_{LZOE}$ ,  $t_{HZCE}$  and  $t_{HZWE}$  are tested with  $C = 5$  pF as in part (b) of Figure 3 on page 5. Transition is measured  $\pm 500$  mV from steady state voltage.

25. A write operation on Port A, where Port A has priority, leaves the data on Port B's outputs undisturbed until one access time after one of the following:  
 BUSY on Port B goes HIGH.  
 Port B's address toggled.

## Switching Characteristics (continued)

Over the Operating Range

Parameter	Description	7C131E-55 7C136E-55 7C136AE-55		Unit
		Min	Max	
$t_{\text{DDD}}$	Write data valid to read data valid <sup>[26]</sup>	–	30	ns
$t_{\text{WDD}}$	Write pulse to data delay <sup>[26]</sup>	–	45	ns
<b>Interrupt Timing</b>				
$t_{\text{WINS}}$	R/W to INTERRUPT set time	–	45	ns
$t_{\text{EINS}}$	CE to INTERRUPT set time	–	45	ns
$t_{\text{INS}}$	Address to INTERRUPT set time	–	45	ns
$t_{\text{OINR}}$	OE to INTERRUPT reset time <sup>[27]</sup>	–	45	ns
$t_{\text{EINR}}$	CE to INTERRUPT reset time <sup>[27]</sup>	–	45	ns
$t_{\text{INR}}$	Address to INTERRUPT reset time <sup>[27]</sup>	–	45	ns

### Notes

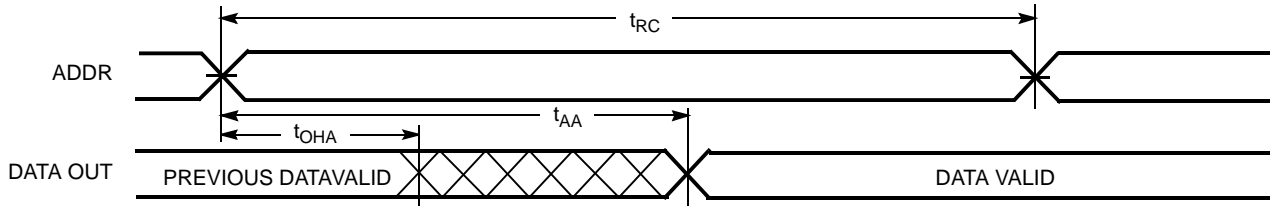
26. A write operation on Port A, where Port A has priority, leaves the data on Port B's outputs undisturbed until one access time after one of the following:  
 BUSY on Port B goes HIGH.  
 Port B's address toggled.  
 CE for Port B is toggled.  
 R/W for Port B is toggled during valid read.

27. These parameters are measured from the input signal changing, until the output pin goes to a high impedance state.

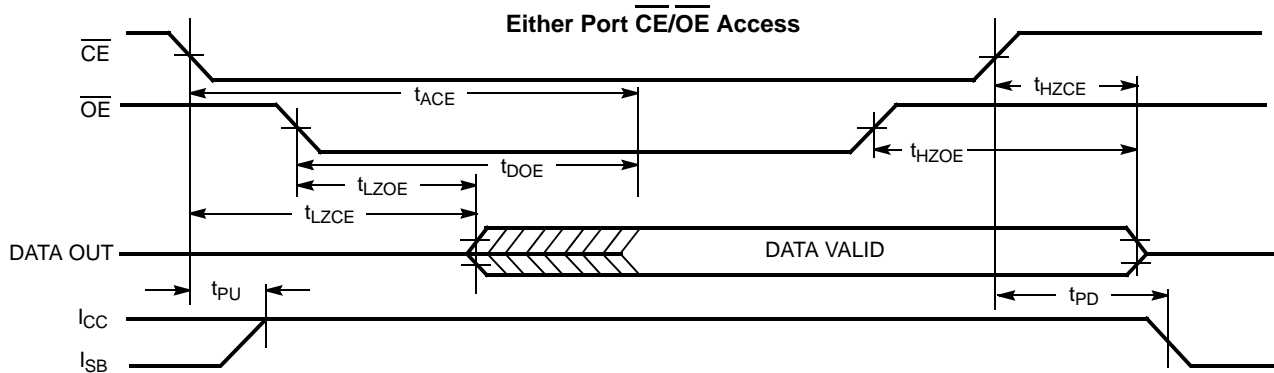


## Switching Waveforms

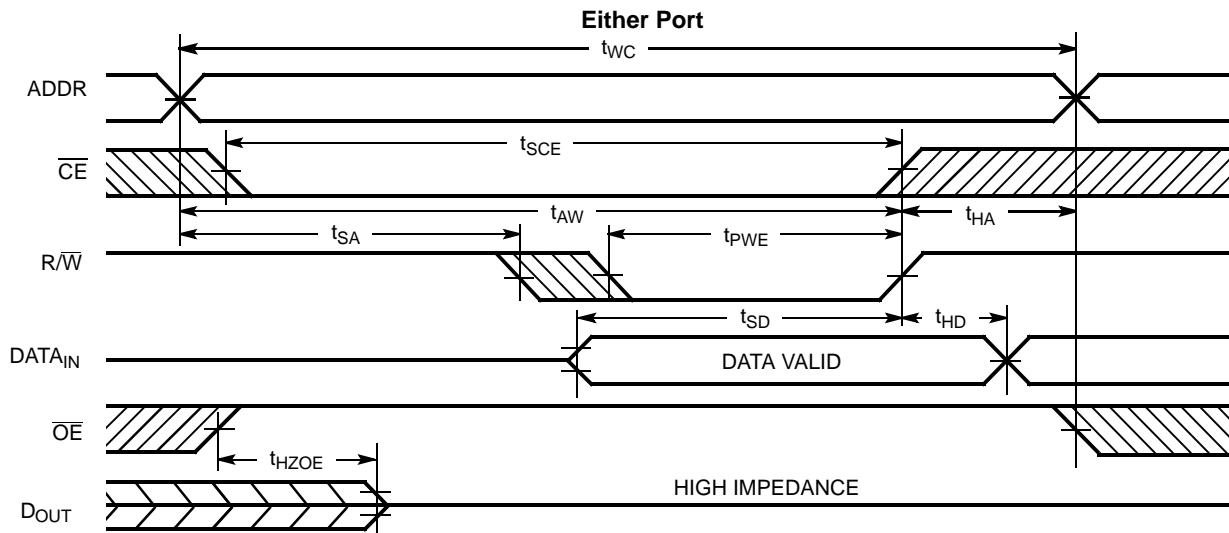
**Figure 4. Read Cycle No. 1 [28, 29]**  
Either Port ADDR Access



**Figure 5. Read Cycle No. 2 [28, 30]**



**Figure 6. Write Cycle No. 1 (OE Three-States Data I/Os – Either Port) [31, 32]**



### Notes

28. R/W is HIGH for read cycle.
29. Device is continuously selected,  $\overline{CE} = V_{IL}$  and  $\overline{OE} = V_{IL}$ .
30. Address valid prior to or coincident with CE transition LOW.
31. The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW and R/W LOW. Both signals must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input setup and hold timing must be referenced to the rising edge of the signal that terminates the write.
32. If  $\overline{OE}$  is LOW during a R/W controlled write cycle, the write pulse width must be the larger of  $t_{PWE}$  or  $t_{HZOE} + t_{SD}$  to allow the data I/O pins to enter high impedance and for data to be placed on the bus for the required  $t_{SD}$ .

### Switching Waveforms (continued)

Figure 7. Write Cycle No. 2 (R/W Three-States Data I/Os – Either Port) [33, 34]

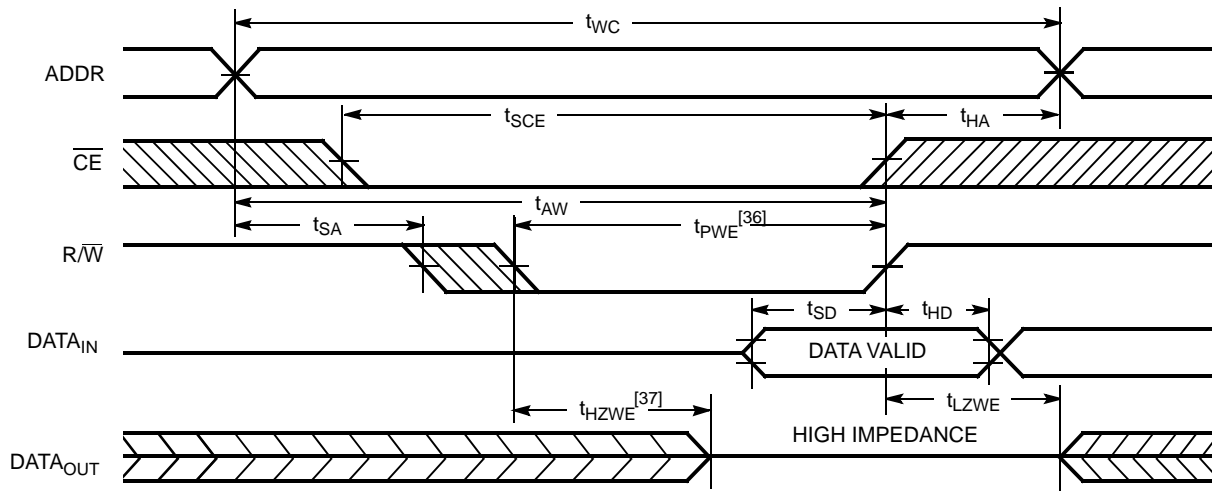
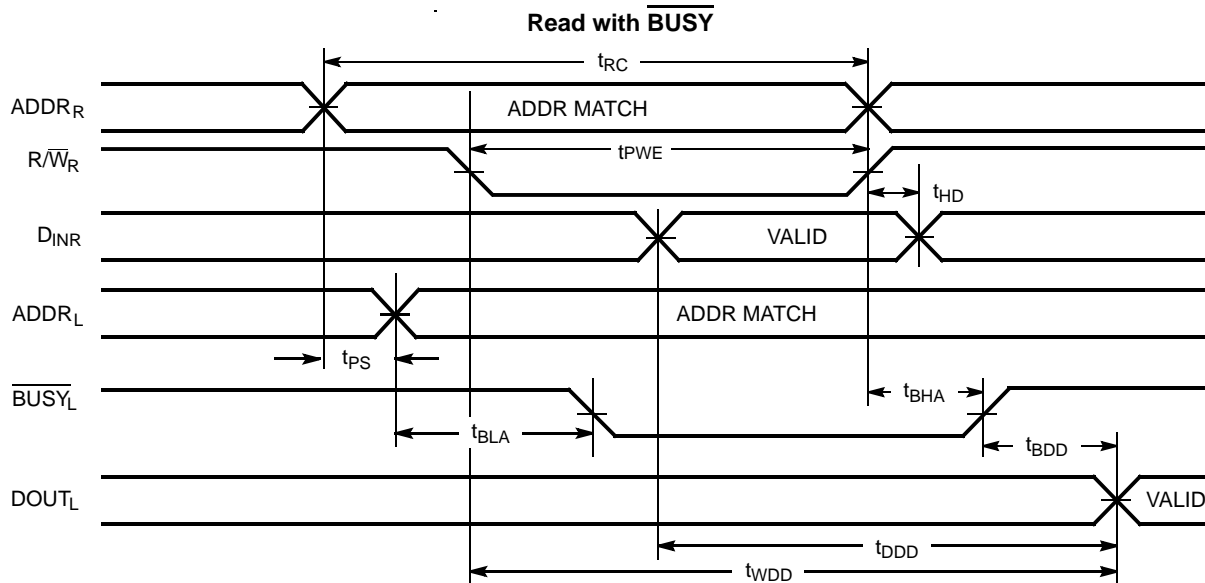


Figure 8. Read Cycle No. 3 [35]



**Notes**

- 33. These parameters are measured from the input signal changing, until the output pin goes to a high impedance state.
- 34. If the  $\overline{\text{CE}}$  LOW transition occurs simultaneously with or after the  $\overline{\text{R/W}}$  LOW transition, the outputs remain in a high impedance state.
- 35.  $\text{CEL} = \text{CER} = \text{LOW}$ .
- 36. If  $\text{OE}$  is LOW during a  $\overline{\text{R/W}}$  controlled write cycle, the write pulse width must be the larger of  $t_{\text{PWE}}$  or  $(t_{\text{HZWE}} + t_{\text{SD}})$  to allow the I/O drivers to turn off and data to be placed on the bus for the required  $t_{\text{SD}}$ . If  $\text{OE}$  is HIGH during a  $\overline{\text{R/W}}$  controlled write cycle, this requirements does not apply and the write pulse can be as short as the specified  $t_{\text{PWE}}$ .
- 37. Transition is measured  $\pm 500$  mV from steady state with a 5 pF load (including scope and jig). This parameter is sampled and not 100% tested.

Switching Waveforms (continued)

Figure 9. Busy Timing Diagram No. 1 ( $\overline{CE}$  Arbitration)<sup>[38]</sup>

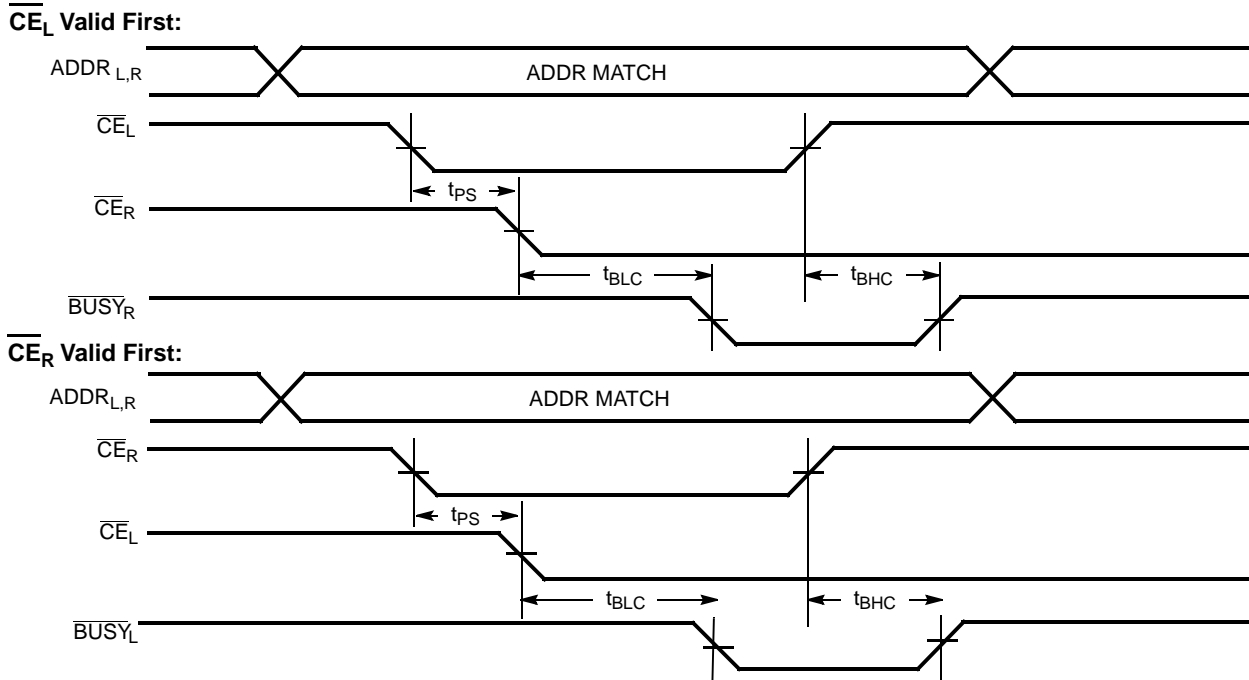
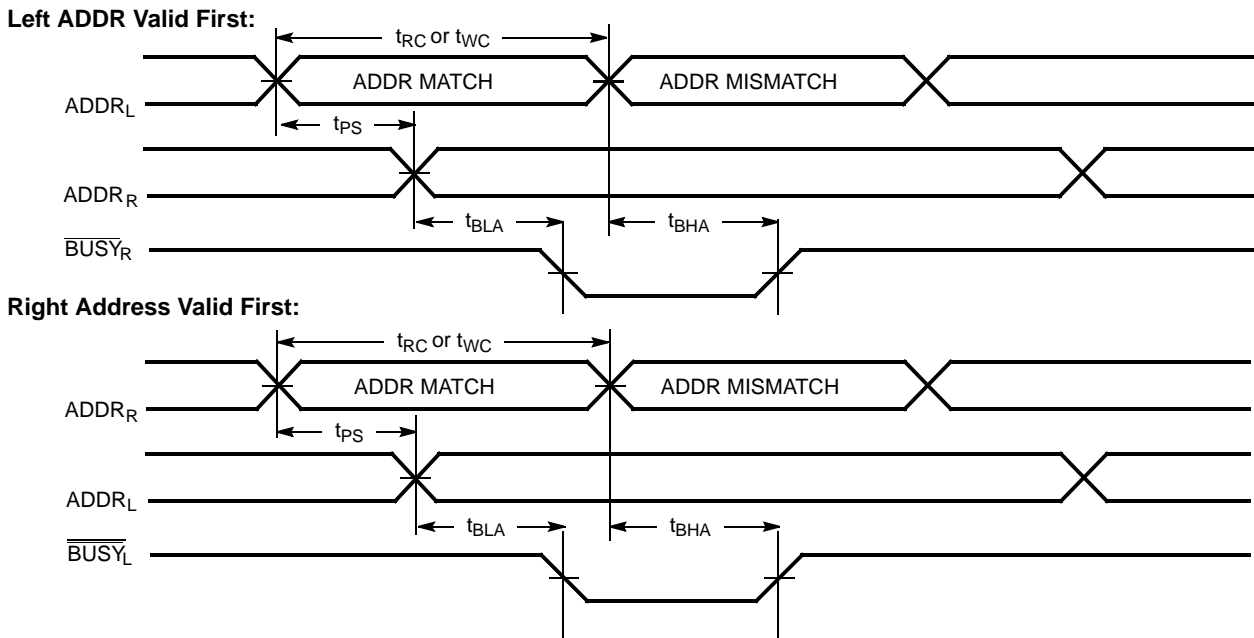


Figure 10. Busy Timing Diagram No. 2 (ADDR Arbitration)<sup>[38]</sup>

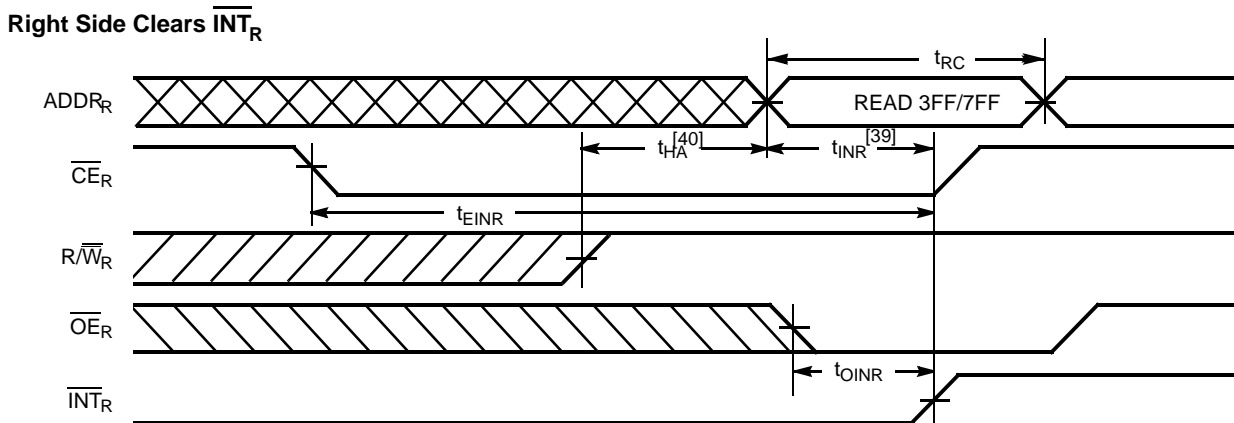
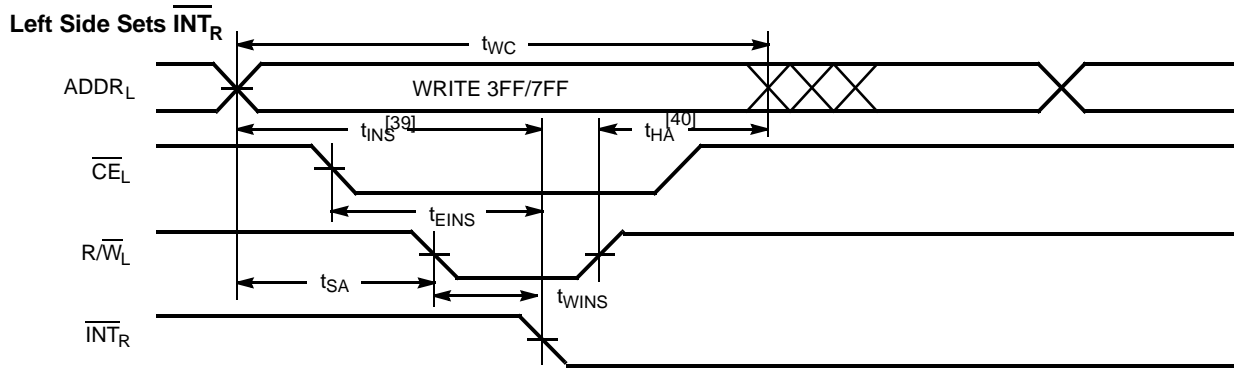


Note

38. If  $t_{PS}$  is violated, the busy signal will be asserted on one side or the other, but there is no guarantee to which side  $\overline{BUSY}$  will be asserted.

Switching Waveforms (continued)

Figure 11. Interrupt Timing Diagrams

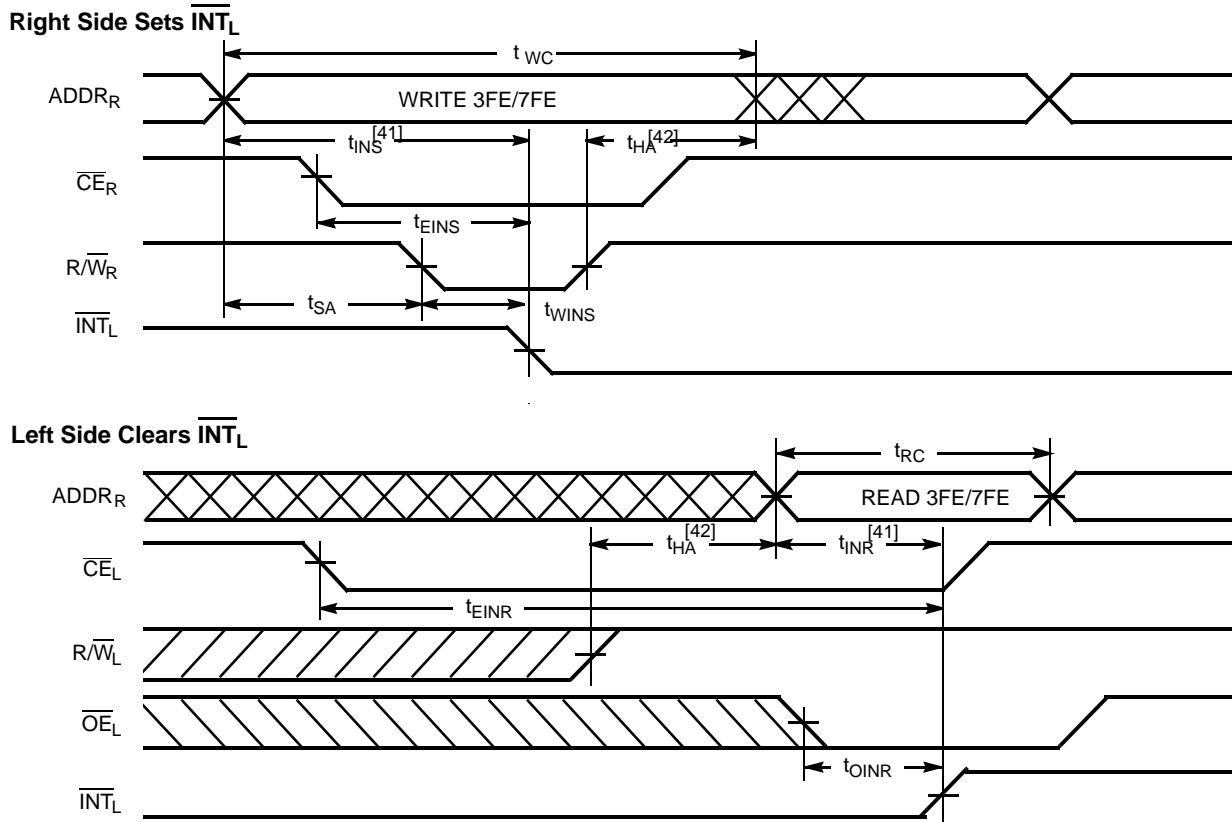


Notes

- 39. Parameter  $t_{INS}$  or  $t_{INR}$  depends on which enable pin ( $\overline{\text{CE}}_L$  or  $\overline{\text{R}}/\overline{\text{W}}_L$ ) is asserted last.
- 40. Parameter  $t_{HA}$  depends on which enable pin ( $\overline{\text{CE}}_L$  or  $\overline{\text{R}}/\overline{\text{W}}_L$ ) is deasserted first.

### Switching Waveforms (continued)

Figure 12. Interrupt Timing Diagrams



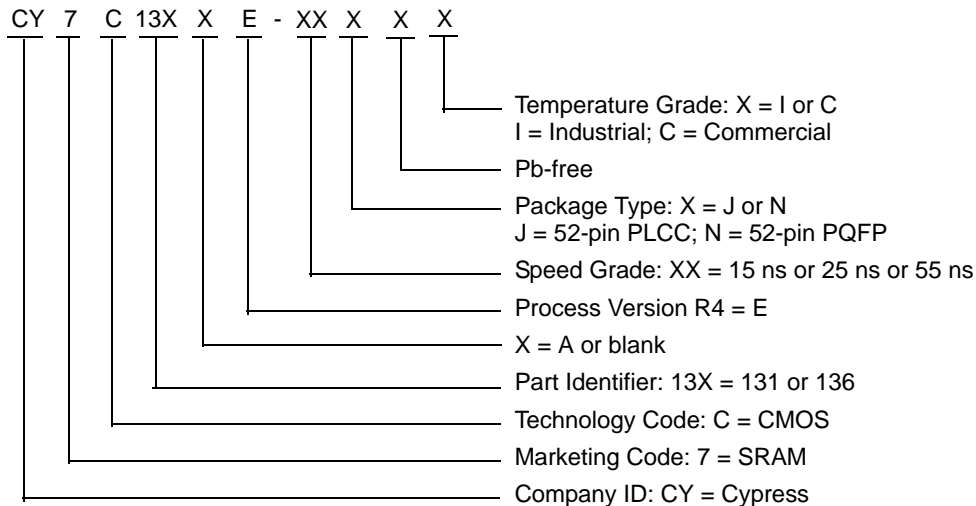
**Notes**

- 41. Parameter  $t_{INS}$  or  $t_{INR}$  depends on which enable pin ( $\overline{CE}_L$  or  $R/\overline{W}_L$ ) is asserted last.
- 42. Parameter  $t_{HA}$  depends on which enable pin ( $\overline{CE}_L$  or  $R/\overline{W}_L$ ) is deasserted first.

### Ordering Information

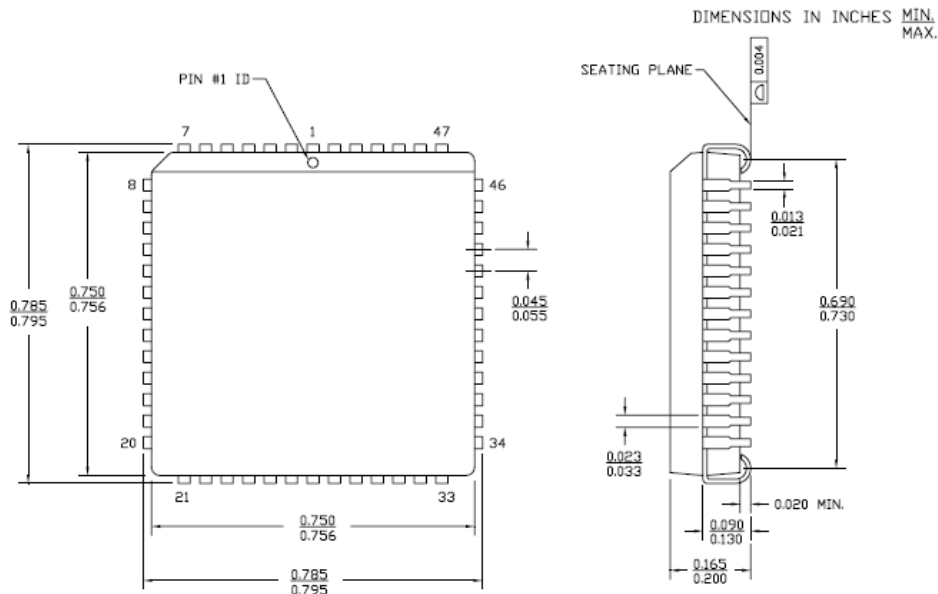
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
<b>1 K x 8 Dual-port SRAM</b>				
15	CY7C131AE-15JXI	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Industrial
	CY7C131E-15NXI	51-85042	52-pin Pb-free Plastic Quad Flatpack	
25	CY7C131E-25JXC	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Commercial
	CY7C131E-25NXC	51-85042	52-pin Pb-free Plastic Quad Flatpack	
55	CY7C131E-55JXC	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Commercial
	CY7C131E-55NXC	51-85042	52-pin Pb-free Plastic Quad Flatpack	
	CY7C131E-55JXI	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Industrial
	CY7C131E-55NXI	51-85042	52-pin Pb-free Plastic Quad Flatpack	
<b>2 K x 8 Dual-port SRAM</b>				
25	CY7C136E-25JXC	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Commercial
	CY7C136E-25NXC	51-85042	52-pin Pb-free Plastic Quad Flatpack	
	CY7C136E-25JXI	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Industrial
55	CY7C136E-55JXC	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Commercial
	CY7C136E-55NXC	51-85042	52-pin Pb-free Plastic Quad Flatpack	
	CY7C136AE-55JXI	51-85004	52-pin Pb-free Plastic Leaded Chip Carrier	Industrial
	CY7C136AE-55NXI	51-85042	52-pin Pb-free Plastic Quad Flatpack	

### Ordering Code Definitions



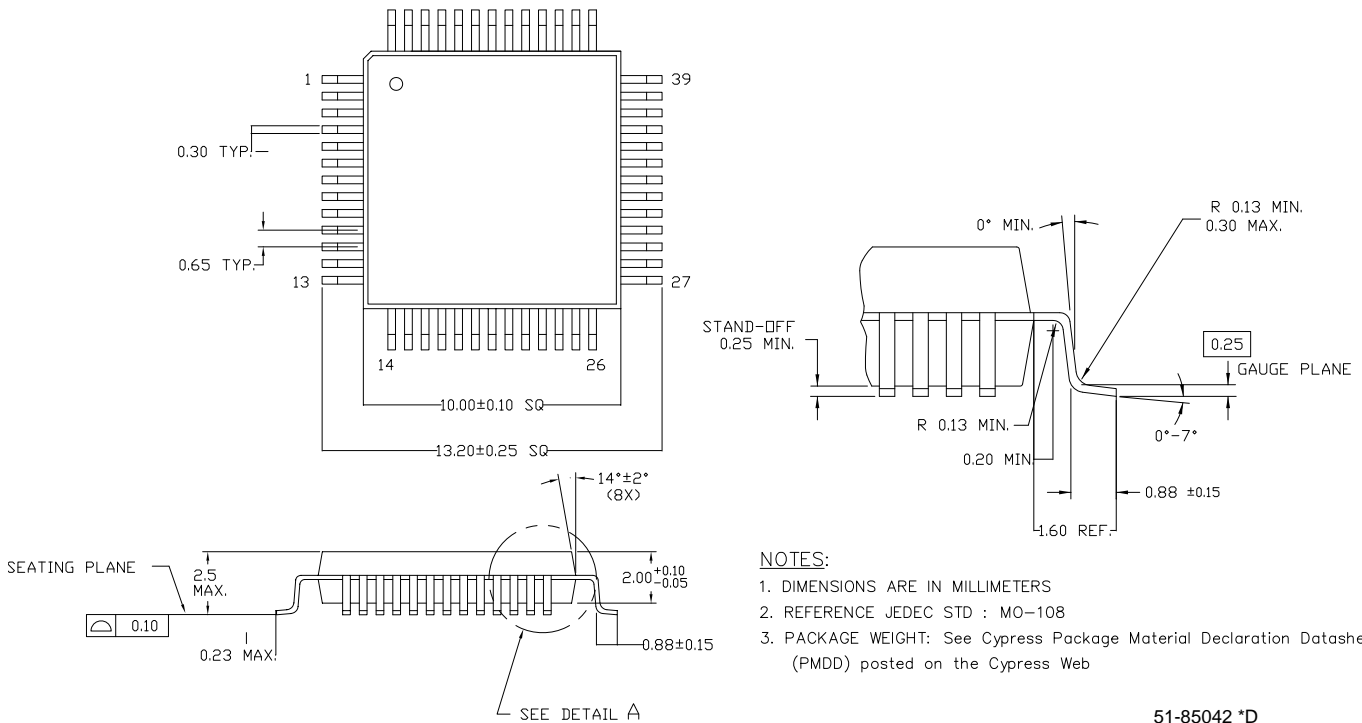
**Package Diagrams**

**Figure 13. 52-pin PLCC (0.756 x 0.756 Inches) J52 Package Outline, 51-85004**



51-85004 \*C

**Figure 14. 52-pin PQFP (10 x 10 x 2.0 mm) N5210 Package Outline, 51-85042**



51-85042 \*D

## Acronyms

Acronym	Description
$\overline{CE}$	chip enable
CMOS	complementary metal oxide semiconductor
I/O	input/output
$\overline{OE}$	output enable
PLCC	plastic leaded chip carrier
PQFP	plastic quad flat package
SRAM	static random access memory
TTL	transistor-transistor logic
$\overline{WE}$	write enable

## Document Conventions

### Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
μA	microampere
mA	milliampere
mV	millivolt
ns	nanosecond
Ω	ohm
%	percent
pF	picofarad
V	volt
W	watt



## Document History Page

Document Title: CY7C131E/CY7C131AE/CY7C136E/CY7C136AE, 1 K / 2 K × 8 Dual-port Static RAM				
Document Number: 001-64231				
Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change
**	3038037	ADMU	09/24/2010	New data sheet
*A	3394800	ADMU	10/04/2011	<p>Changed status from Preliminary to Final.</p> <p>Updated <a href="#">Maximum Ratings</a> (Removed (Pin 48 to Pin 24)).</p> <p>Updated <a href="#">Electrical Characteristics</a> (changed minimum value of I<sub>OZ</sub> parameter from -10 μA to -20 μA, changed maximum value of I<sub>OZ</sub> parameter from +10 μA to +20 μA and changed maximum value of I<sub>SB3</sub> from 0.5 mA to 15 mA for both Commercial and Industrial temperature ranges).</p> <p>Updated <a href="#">Package Diagrams</a> (Updated revision of 51-85004 from *B to *C and revision of 51-85042 from *A to *C).</p> <p>Updated in new template.</p>
*B	3403147	ADMU	10/12/2011	No technical updates.
*C	3435230	ADMU	11/17/2011	<p>Updated <a href="#">Features</a> (Removed a feature "Expandable data bus width to 16 bits or more using Master/Slave chip select when using more than one device." and updated another feature to read as "BUSY output flag to indicate access to the same location by both ports.").</p> <p>Updated <a href="#">Functional Description</a> (Updated the sentence in the first paragraph to read as "The CY7C131E / CY7C131AE / CY7C136E / CY7C136AE can be used as a standalone dual-port static RAM.").</p> <p>Updated Note 2 to read as "BUSY is a push-pull output. No pull-up resistor required.".</p> <p>Updated Note 3 to read as "Interrupt: push-pull output. No pull-up resistor required.".</p> <p>Updated <a href="#">Maximum Ratings</a> (Removed "(per MIL-STD-883, Method 3015)").</p> <p>Updated <a href="#">Electrical Characteristics</a> (Removed the Note "See the last page of this specification for Group A subgroup testing information." and its reference in Parameter column.).</p> <p>Updated <a href="#">Capacitance[10]</a> (Changed maximum value of C<sub>IN</sub> parameter from 10 pF to 15 pF).</p> <p>Updated <a href="#">AC Test Loads and Waveforms</a>.</p> <p>Updated <a href="#">Switching Characteristics</a> (Removed the Note "See the last page of this specification for Group A subgroup testing information." and its reference in Parameter column.).</p> <p>Updated <a href="#">Switching Characteristics</a> (Changed the minimum value of t<sub>OHA</sub> from 0 ns to 3 ns).</p> <p>Removed the section "Typical DC and AC Characteristics".</p> <p>Removed the section "Reference Documents".</p>
*D	3620277	ADMU	06/15/2012	<p>Added footnotes 9, 13, 17, 20, 36, 37, 39, 40, 41, and 42.</p> <p>Missing overbars updated.</p> <p>Removed "Slave Diagrams".</p> <p>Updated Figure 3 with value 5 ns.</p> <p>Updated <a href="#">Maximum Ratings</a> (updated Static discharge voltage from 2001 V to 1100 V).</p> <p>Corrected the typo in <a href="#">Electrical Characteristics</a>.</p> <p>Updated <a href="#">Package Diagrams</a> (51-85042 from Rev *C to *D).</p> <p>Updated I<sub>CC</sub> parameters in <a href="#">Electrical Characteristics</a> table.</p> <p>Updated Typical Operating Current parameters in <a href="#">Selection Guide</a>.</p>

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